

## Product Change Notification / SYST-29IQOM190

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30-Sep-2022

## **Product Category:**

8-bit Microcontrollers

## **PCN Type:**

**Document Change** 

## **Notification Subject:**

ERRATA - PIC18(L)F65/66K40 Family Silicon Errata and Data Sheet Clarification Revision

## **Affected CPNs:**

SYST-29IQOM190\_Affected\_CPN\_09302022.pdf SYST-29IQOM190\_Affected\_CPN\_09302022.csv

## **Notification Text:**

SYST-29IQOM190

Microchip has released a new Errata for the PIC18(L)F65/66K40 Family Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at PIC18(L)F65/66K40 Family Silicon Errata and Data Sheet Clarification.

**Notification Status:** Final

**Description of Change:** Remove 2.1.2 Add 2.1.6, 2.1.7, 2.1.8, 2.4.2, 2.5.3, 2.10.1, 2.11.1, 2.12.1, 2.13.1. Remove all Data Sheet Clarifications except ADC offset Error should be -+3.0 LSb. Other minor editorial corrections.

Impacts to Data Sheet: None

**Reason for Change:** To Improve Productivity

**Change Implementation Status: Complete** 

Date Document Changes Effective: 30 Sep 2022

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices::N/A
Attachments:
PIC18(L)F65/66K40 Family Silicon Errata and Data Sheet Clarification
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# PIC18(L)F65/66K40

# PIC18(L)F65/66K40 Family Silicon Errata and Data Sheet Clarification

The PIC18(L)F65/66K40 devices that you have received conform functionally to the current device data sheet (DS40001842E), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in the table below.

The errata described in this document will be addressed in future revisions of the PIC18(L)F65/66K40 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current.

**Table 1. Silicon Device Identification** 

Part Number	Device ID	Revision ID	
		A3	A4
PIC18F65K40	0x6B00	0xA003	0xA004
PIC18LF65K40	0x6B60	0xA003	0xA004
PIC18F66K40	0x6AE0	0xA003	0xA004
PIC18LF66K40	0x6B40	0xA003	0xA004

# 1. Silicon Issue Summary

Table 1-1. Silicon Issue Summary

Module	Feature	Item No.	Issue Summary	Affected Revisions	
				А3	A4
	ADC Conversion	2.1.1.	Delay of one instruction cycle required prior to setting the ADGO bit when using ADCRC as the ADCC clock source	Х	
	ADCRC Oscillator Operation in Sleep	2.1.2.	The ADCRC oscillator does not stop after conversion is complete in Sleep mode	Х	Х
	ADC Conversion with FVR	2.1.3.	Using FVR as the ADC positive voltage reference can cause missing codes	Х	Х
	ADC conversion with F <sub>OSC</sub> as clock	2.1.4.	The ADGO bit remains set when using F <sub>OSC</sub> as clock source with clock divider	Х	X
Analog-to-Digital Converter (ADC)	ADC operation in Burst Average mode	2.1.5.	The ADCNT register does not increment past '0b1' in Burst Average mode with double sampling enabled	Х	X
	Double Sample Conversions	2.1.6.	An unexpected acquisition time is added between the first and second conversions.	Х	X
	ADC Acquisition Time	2.1.7.	Conversion during SLEEP mode when ADACQ=0 affects results on values in the upper half of the 10-bit range. The analog input is disconnected for 3-4 uS and the first bit of the result becomes zero.	Х	Х
	ADC Short in Precharge State	2.1.8.	ADC shorts briefly in pre-charge state when the corresponding analog pin is selected as an output.	Х	X
PIC18 Debug	Data Write Match Breakpoints	2.2.1.	Data write match breakpoints do not work when used on a location GSR space	X	
Executive	Single Step Function (SSTEP)	2.2.2.	Single Step function does not execute at SW Breakpoint.	Х	X
PIC18 Core	TBLRD	2.3.1.	TBLRD requires NVMREG value to point to appropriate memory	X	
Program Flash	Endurance of PFM Cell	2.4.1.	Endurance of the PFM cell is lower than specified	X	X
Memory (PFM)	Back to Back Writes	2.4.2.	Repetitive writes may cause write/erase failures.	X	Х
Moon	SMBus 2.0 Voltage Level	2.5.1.	Input low-voltage threshold level is dependent on $\rm V_{\rm DD}$	X	Х
MSSP	SPI	2.5.1.	SSPBUF may become corrupted	Χ	Х
	I2C	2.5.3.	Acknowledge failure on LF devices only	Х	

Module	Feature	Item No.	Issue Summary	Affected Revisions	
				А3	A4
	Min V <sub>DD</sub> Specification	2.6.1.	V <sub>DDMIN</sub> specifications are changed for LF devices only for -40°C and 0°C		Х
Electrical Specifications	FVR Specification	2.6.2.	FVR specifications require use above -20°C	Х	Х
•	Analog-to-Digital Converter	2.6.3.	ADC offset error specification is +/-3.0 LSb	Х	Х
Timer0	Clock Source	2.7.1.	TMR0 does not function properly in Sync mode	Х	Х
Windowed Watchdog Timer	WWDT operation in Doze mode	2.8.1.	Erroneous window violation error occurs in Doze mode	Х	Х
NVM	NVMERR bit operation	2.9.1.	NVMERR bit is set incorrectly due to specific Reset events	Х	Х
SMT	Reset bit	2.10.1.	Module stops working if RST is set while prescaler setting is not zero	Х	Х
Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART)	Transmit mode	2.11.1.	Possible duplicate byte transmitted	X	X
Capture/ Compare/PWM Module (CCP)	PWM mode	2.12.1.	Duty cycle values are incorrect	Х	Х
In-Circuit Serial Programming <sup>™</sup>	Low-Voltage Programming	2.13.1.	Low-Voltage Programming is not possible when V <sub>DD</sub> is below BORV while BOR is enabled	Х	Х

## 2. Silicon Errata Issues



**Notice:** This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the bold font in the following tables apply to the current silicon revision.

## 2.1 Module: ADCC - Analog-to-Digital Converter with Computation

#### 2.1.1 ADC Conversion

When using the ADCRC as the clock source for ADCC, there is a delay of one instruction cycle between the user setting the ADGO bit and being able to read it set. This can lead to a false conversion complete scenario (i.e., ADGO being cleared), depending if the user code has a bit clear test BTFSC instruction on the ADGO bit, immediately after setting the ADGO bit. See code example below.

```
BSF ADCONO, ADGO ; Start conversion
BTSFC ADCONO, ADGO ; Is conversion done?
GOTO $-1 ; No, test again
```

#### Work around

Add a NOP instruction after setting the ADGO bit and before testing the bit for completion of conversion. See code example below.

```
BSF ADCONO, ADGO ; Start conversion

NOP

BTSFC ADCONO, ADGO ; Is conversion done?

GOTO $-1 ; No, test again
```

#### **Affected Silicon Revisions**

А3	<b>A4</b>
X	

## 2.1.2 ADCRC Oscillator Operation in Sleep

If the part is in Sleep and the ADCRC oscillator is used as clock source to the ADC, the oscillator continues to run after the conversion is complete. This will increase the current consumption in Sleep mode. The oscillator will stop after the device exits Sleep mode and resumes normal code execution.

## Work around

None.

#### **Affected Silicon Revisions**



#### 2.1.3 Missing Codes with FVR Reference

Using the FVR as the positive voltage reference for the ADC can cause an increase in missing codes.

#### Work around

#### Method 1:

Increase the bit conversion time, known as T<sub>AD</sub>, to 8 µs or higher.

#### Method 2:

Use V<sub>DD</sub> as the positive voltage reference to the ADC.

#### **Affected Silicon Revisions**

А3	<b>A4</b>
X	X

## 2.1.4 ADC GO Bit May Remain Set When the Clock Source is Fosc

When using  $F_{OSC}$  as the clock source (ADCON0.CS = 0) and any clock divider setting other than  $F_{OSC}/2$  is selected, the ADGO bit remains set and the conversion does not complete.

#### Work around

#### Method 1:

When using  $F_{OSC}$  as the clock source (ADCON0.CS = 0), clear the ADCLK register value to zero (ADCLK.CS = 0) and ensure that the  $F_{OSC}$  frequency does not violate any timing requirements for the ADC.

#### Method 2:

Use ADCRC as the clock source (ADCON0.CS = 1).

#### **Affected Silicon Revisions**



## 2.1.5 ADCC Burst Average Mode

When the ADCC is operated in Burst Average mode (ADMD = 0b011 in the ADCON2 register) while enabling noncontinuous operation and double-sampling (ADCONT = 0 in the ADCON0 register and ADDSEN = 1 in the ADCON1 register), the value in the ADCNT register does not increment beyond '0b1' toward the value in the ADRPT register.

#### Work around

When operating the ADCC in Burst Average mode with double-sampling, enable continuous operation of the module (ADCONT = 1 in the ADCON0 register) and set the Stop-on-Interrupt bit (the ADSOI bit in the ADCON3 register). After the interrupt occurs, perform appropriate threshold calculations in the software and retrigger ADCC as necessary.

Alternatively, if the CPU is in Low-Power Sleep mode, the ADCC in noncontinuous Burst Average mode can be operated with a single ADC conversion (ADDSEN = 0 in the ADCON1 register). Doing so compromises noise immunity for lower power consumption by preventing the device from waking up to perform threshold calculations in the software.

А3	<b>A4</b>
X	Х

#### 2.1.6 **Double Sample Conversions**

When enabling a Double Sample Conversion (DSEN = 1), with no Precharge time (ADPRE = 0) and no Acquisition time (ADACQ = 0), the maximum number of cycles of acquisition time is inserted prior to the second conversion. The first conversion will be performed as expected with no Precharge time and no Acquisition time. It is only between the first and second conversions where a maximum number of cycles of Acquisition time is performed unexpectedly.

#### Work around

- Method 1: Disable Double Sample Conversion (DSEN = 0) and perform two single conversions back to back.
- Method 2: If adding acquisition time is acceptable, then select no Precharge time, along with the desired Acquisition time.

#### **Affected Silicon Revisions**

А3	<b>A</b> 4
X	X

#### 2.1.7 **ADC Conversion Acquisition Time in Sleep (ADCC)**

Conversion during SLEEP mode when ADACQ=0 affects results on values in the upper half of the 10-bit range. The analog input is disconnected for 3-4 uS and the first bit of the result becomes zero.

#### Work around

Add 5 counts of ADACQ time.

#### Affected Silicon Revisions



#### 2.1.8 **ADC Short in Pre-Charge State**

During the precharge state, if the analog pin on which the ADC conversion is performed is selected to be an output (such as LATx or ADGRDx), there is a 20 ns short between pullup/down and the external low/high states, resulting in an inaccurate ADC conversion reading.

#### Work around

None.

#### Affected Silicon Revisions

А3	<b>A</b> 4
X	X

#### 2.2 Module: PIC18 Debug Executive

#### 2.2.1 **Data Write Match Breakpoints**

If the data in a GPR location is modified using any arithmetic instruction like INCF, ADDWF, SETF, CLRF, etc., the data write match breakpoint does not work. It works with MOVF, which moves the data into the same memory location. See code examples below.

1.

**Errata** 

LOOP		
INCF	0x08	;Doesn't break when data
		breakpoint set @ 0x08
		with data match for 0xAA
GOTO LOOP		

#### 2.

MOVLB MOVLW MOVF	0x00 0xAA 0x08	;Breaks when data breakpoint set @ 0x08 with data match for 0xAA
GOTO LOOP		

#### Work around

Use data write breakpoints without matching wherever possible.

#### **Affected Silicon Revisions**

А3	<b>A4</b>	
X		

## 2.2.2 Single Step function does not execute at SW Breakpoint.

The SW breakpoint occurs, but the SSTEP function does not execute at the breakpoint.

#### Work around

None.

#### **Affected Silicon Revisions**

А3	<b>A4</b>	
X	X	

## 2.3 Module: PIC18 Core

## 2.3.1 TBLRD Requires NVMREG Value to Point to Appropriate Memory

The affected silicon revisions of the PIC18(L)F65/66K40 devices improperly require the NVMREG[1:0] bits in the NVMCON register to be set for TBLRD access of the various memory regions. The issue is most apparent in compiled C programs when the user defines a const type and the compiler uses <code>TBLRD</code> instructions to retrieve the data from Program Flash Memory (PFM). The issue is also apparent when the user defines an array in RAM for which the compiler creates start-up code, executed before main(), that uses <code>TBLRD</code> instructions to initialize RAM from PFM.

#### Work around

Assembly code:

Set the NVMREG[1:0] bits to select the appropriate memory region before executing TBLRD instructions.

C code:

Create an assembly file named powerup.as and include this file with the other files in the project. This file will change the NVMREG[1:0] bits to point to program Flash before any code is executed. Contents of the powerup.as file:

```
#include <xc.inc>
GLOBAL powerup, start
```

**Errata** 

```
PSECT powerup, class=CODE, delta=1, reloc=2
powerup:

BSF NVMCON1, 7
GOTO start
end
```

If there is a need to change the NVMREG[1:0] value to anything other than '10' and the Interrupt Service Routine uses constants or literal strings, then interrupts must be disabled before the change and restored to '10' before interrupts are enabled.

#### Affected Silicon Revisions

А3	<b>A4</b>	
X		

## 2.4 Module: Program Flash Memory (PFM)

## 2.4.1 Endurance of PFM is Lower than Specified

The Flash memory cell endurance specification (Parameter MEM30) is 1K cycles.

#### Work around

None.

#### Affected Silicon Revisions

А3	<b>A4</b>
X	X

## 2.4.2 PFM Back to Back Writes

When repetitive writes to non-volatile memory (Program Flash Memory) are performed, it could result in write/erase failures at some locations. The issue is due to latent timing in the non-volatile memory controller which can cause the write instruction to fail under certain conditions.

#### Work around

To avoid the issue, it is recommended to wait an additional 100us after the NVMCON1.WR bit has been set, allowing for the last word to be loaded into the write buffer.

```
NVMCON2 = 0x55;
NVMCON2 = 0xAA;
NVMCON1bits.WR = 1;
__delay_us(100);
NVMCON1bits.WREN = 0;
```

Note: The \_\_delay\_us() function uses a #define macro definition. For the intrinsic \_\_delay\_us() function to work correctly, the value of the \_XTAL\_FREQ must be clearly defined. This macro is defined in the device\_config.h file if the code is generated using MCC. The value of XTAL\_FREQ is equal to the system clock frequency.



## 2.5 Module: MSSP

## 2.5.1 SMBus 2.0 Voltage Level

The input low-voltage threshold level (V<sub>IL</sub>) depends on V<sub>DD</sub>, as follows:

$$V_{IL} = 0.7$$
 for  $V_{DD} < 4V$ 

$$V_{IL} = 0.8$$
 for  $V_{DD} > 4V$ 

#### Work around

None.

#### **Affected Silicon Revisions**



#### 2.5.2 MSSP SPI Client Mode

When operating in SPI Client mode, if the incoming SCK clock signal arrives during any of the conditions below, the SSPBUF Transmit Shift Register (TSR) may become corrupted. The byte transmitted to the client cannot be ensured to be correct, and the state of the WCOL bit may or may not indicate a write collision.

These conditions include:

- · A write to an SFR
- · A write to RAM following an SFR read
- A write to RAM prior to an SFR read

#### Work around

## Method 1 (Interrupt based using SS):

- 1. Connect the SS line to both the SS input and either an INT or IOC input pin.
- Enable INT or IOC interrupts (interrupt on falling edge if available, otherwise check that SS == 0 when the interrupt occurs).
- 3. Load SSPBUF with the data to be transmitted.
- 4. Continue program execution.
- 5. When the Interrupt Service Routine (ISR) is invoked, do either of the following:
  - a. Add a delay that ensures the first SCK clock will be complete, or
  - b. Poll SSPSTAT.BF (while(BF == 0)), and wait for the transmission/reception to complete.

## Method 2 (Bit polling based using $\overline{SS}$ ):

- 1. Load SSPBUF with the data to be transmitted.
- 2. Poll the  $\overline{SS}$  line and wait for the  $\overline{SS}$  to go active (while(!PORTx. $\overline{SS}$  == 0)).
- 3. When  $\overline{SS}$  is active ( $\overline{SS} == 0$ ), do either of the following:
  - a. Add a delay that ensures the first SCK clock will be complete, or
  - b. Poll SSPSTAT.BF (while(BF == 0)), and wait for the transmission/reception to complete.

Once one of these two methods are complete, it is safe to return to program execution.

## Method 3 (SS not available):

- Load SSPBUF with the data to be transmitted.
- 2. Poll SSPSTAT.BF (while(BF == 0)), and wait for the transmission/reception to complete.

#### Affected Silicon Revisions

A3 A4



## 2.5.3 SMBus 2.0 Voltage Level

When using the MSSP to perform I2C communication and the voltage for V<sub>DD</sub> is above 3.0 volts, the Acknowledge signal (ACK) does not always occur after the second address byte is received, as expected. This issue exhibits itself when the MSSP is configured either for 7-bit or 10-bit addressing and in either Master or Slave mode.

The issue occurs more frequently when using 10-bit addressing in Slave mode and the lower address bits (A7-A0) are transmitted by the Master on the SDA line.

#### Work around

Do not exceed 3.0 volts on V<sub>DD</sub> when using an LF device.

#### Affected Silicon Revisions

А3	<b>A</b> 4
X	

## 2.6 Module: Electrical Specifications

## 2.6.1 Min V<sub>DD</sub> Specification (LF Devies Only)

V<sub>DDMIN</sub> specifications are changed for LF devices only at -40°C and 0°C as below.

 $V_{DDMIN}$  for -40°C to 0°C = 2.3V

 $V_{DDMIN}$  for 0°C to 25°C = 2.1V

## Work around

None.

## **Affected Silicon Revisions**



## 2.6.2 FVR - Fixed Voltage Reference

At temperatures below -20°C, the output voltage for the FVR may be greater than the levels specified in the data sheet. This will apply to all three gain amplifier settings, (1X, 2X, 4X). The affected parameter numbers found in the data sheet are: FVR01 (1X gain setting), FVR02 (2X gain setting), and FVR03 (4X gain setting).

### Work around

At temperatures above -20°C, the stated tolerances in the data sheet remain in effect. Operate the FVR only at temperatures above -20°C.

#### **Affected Silicon Revisions**



## 2.6.3 ADC - Analog-to-Digital Converter

The table containing the Offset Error specification (AD04: EOFF) for the Analog-to-Digital Converter is modified. The updated value for Offset Error specification is +/- 3.0 LSb.

#### Work around

None.

#### **Affected Silicon Revisions**



## 2.7 Module: Timer0

#### 2.7.1 Synchronous mode

Do not operate Timer0 in Synchronous mode.

#### Work around

Use TMR0 in Asynchronous Mode by setting the T0ASYNC bit in T0CON1 register. All functions of Timer0 operate properly in Asynchronous mode

#### **Affected Silicon Revisions**



## 2.8 Module: Windowed Watchdog Timer (WWDT)

## 2.8.1 Window Operation in Doze Mode

When the Windowed mode of operation is enabled in Doze mode, a window violation error is issued even though the window is open and has been armed. This condition occurs only when the window size is set to a value other than 100% open.

## Work around

#### Method 1:

Use the Windowed mode of operation in any mode other than Doze. If disabling the Doze mode is not an option, use the WWDT module without the window being enabled.

#### Method 2:

If the device is in Doze mode, perform the arming process for the window in Normal mode and return to the Doze mode.

#### Method 3:

If there is an Interrupt Service Routine (ISR) in the application code, the arming within the window can be done inside the ISR with the ROI bit of the CPUDOZE register being set.



## 2.9 Module: Nonvolatile Memory (NVM)

#### 2.9.1 **NVMERR**

When a Reset is issued while an NVM high-voltage operation is in progress, the NVMERR bit in the NVMCON0 register is set as expected. After clearing the NVMERR bit, if a Reset reoccurs, the NVMERR bit is set again regardless of whether an NVM operation is in progress or not. A successful write operation will clear the NVMERR condition.

#### Work around

None.

#### **Affected Silicon Revisions**



## 2.10 Module: SMT

#### 2.10.1 Reset Bit

If the SMT clock prescaler is set to any value other than '00', setting the RST bit will cause the module to stop working. The RST bit will remain at the value '1', the counter will not increment, and no interrupts will be generated. The problem is cleared by turning the module off and on, or by a device reset.

#### Work around

- Method 1: Do not set the RST bit; manual reset is usually not required for typical operation because the
  measurement logic will reset the counter automatically.
- · Method 2: Write zero to the counter manually. The module enable or the clock should be disabled during this.
- Method 3: Use 1:1 prescaler (PS = 00).
- Method 4: Use the CLKREF subsystem to provide a prescaled clock and set PS = 00.

#### **Affected Silicon Revisions**



# 2.11 Module: Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART)

## 2.11.1 Double Byte Transmit

Under certain conditions, a byte written to the TXREG register can be transmitted twice. This happens when a byte is written to TXREG just as the TSR register becomes empty. This new byte is immediately transferred to the TSR register, but also remains in the TXREG register until the completion of the current instruction cycle. If the new byte in the TSR register is transmitted before this instruction cycle has completed, the duplicate in the TXREG register will subsequently be transferred to the TSR register on the following instruction clock cycle and transmitted.

#### Work around

Method 1: Monitor the Transmit Interrupt Flag (TXIF) bit. Writes to the TXREG register can be performed once the TXIF bit is set, indicating that the TXREG register is empty. If using this method, ensure that the second byte is filled

in the TXREG before bit 6 of the first byte is transmitted. If the delay is more than six bit times, there is a possibility of double byte transmission.

Method 2: Monitor the TMRT bit of the TXxSTA register. Writes to the TXREG register can be performed once the TMRT bit is set, indicating that the Transmit Shift Register (TSR) is empty. This work around can be applied if back-to-back transmissions are not necessary.

#### **Affected Silicon Revisions**



## 2.12 Module: Capture/Compare/PWM Module (CCP)

## 2.12.1 Wrong Duty Cycle for CCP Module

While in PWM mode and the Timer2 prescaler is configured to 1:1, the duty cycle of the PWM output is as expected. When the Timer2 prescaler is changed to a value other than 1:1, while T2PR = 0 (PWM resolution of two bits), the expected duty cycle is wrong. The corrected duty cycle values are shown in the table below.

**Table 2-1. Corrected Duty Cycle Values** 

Prescaler/CCPR	0	1	2	3	4
1:1	0%	25%	50%	75%	100%
1:2	50%	75%	50%	75%	100%
1:41:128	75%	75%	75%	75%	100%

#### Work around

None.

#### **Affected Silicon Revisions**



# 2.13 Module: Low-Voltage In-Circuit Serial Programming<sup>™</sup> (LVP)

## 2.13.1 Low-Voltage Programming Not Possible

Low-Voltage Programming is not possible when  $V_{DD}$  is below the selected BORV voltage level, while BOR is enabled.

#### Work around

Method 1: Disable BOR to use Low-Voltage Programming.

Method 2: Raise V<sub>DD</sub> above the selected BORV level while using Low-Voltage Programming.



## 3. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS40001842E):

#### Note:

Corrections are shown in bold. Where possible, the original bold text formatting has been removed for clarity.

## 3.1 Module: Electrical Specifications

## 3.1.1 ADC Offset Error

Table 38-13 containing the Offset Error Specification (AD04: EOFF) for the Analog-to-Digital Converter is modified.

The updated value for Offset Error Specification (AD04) is ±3.0 LSb.

# 4. Appendix A: Revision History

Doc Rev.	Date	Comments	
G	09/2022	Remove 2.1.2 Add 2.1.6, 2.1.7, 2.1.8, 2.4.2, 2.5.3, 2.10.1, 2.11.1, 2.12.1, 2.13.1. Remove all Data Sheet Clarifications except ADC offset Error should be -+3.0 LSb. Other minor editorial corrections	
F	03/2021	Added silicon revisions 2.1.5, 2.1.6, 2.5.2, 2.6.3 2.8.1 and 2.9.1. Data Sheet Clarifications: Added Module 3.2 (Pin Diagrams), Module 3.3 (Electrical Specifications), Module 3.4 (Analog-to-Digital Converter) and Module 3.5 (Capture/Compare/PWM (CCP) Module).	
E	06/2018	Data Sheet Clarifications: Added Module 2: Pin Allocation Tables (ADC Channel Selection).	
D	05/2018	Added Module 7: Electrical Specifications (FVR) and Module 8: Timer0. Data Sheet Clarifications: Added Module 1 (Core Features).	
С	03/2017	Added Module 6: Electrical Specifications for LF Devices Only. Other minor corrections.	
В	12/2016	Added modules 1.3. ADCRC Oscillator Operation in Sleep, 1.4. ADC Conversion with FVR, and 5. MSSP to the Silicon Errata Issues section. Other minor corrections.	
Α	09/2016	Initial release of this document.	

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## SYST-29IQOM190 - ERRATA - PIC18(L)F65/66K40 Family Silicon Errata and Data Sheet Clarification Revision

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